



TAOGLAS®



Datasheet

Part No:
IP.1621.25.4.A.02

Description
4mm thick Iridium Patch Antenna

Features:
Single Feed Ceramic Patch
Covering: Iridium®
Dims: 20.0 x 20.0 x 4.0 mm
RoHS & Reach Compliant

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ISO 9001:2015
Certified



Taiwan
ISO 9001:2015
Certified



1. Introduction



The Taoglas **IP.1621.25.4.A.02** is a compact ceramic patch antenna designed for Iridium® satellite communication applications, delivering reliable performance in a miniaturized form factor. Utilizing Taoglas XtremeGain™ technology, the antenna is optimized to provide excellent signal reception while minimizing size, making it ideal for space-constrained devices requiring global satellite connectivity.

With its low-profile ceramic construction, the antenna can be easily integrated into a wide range of embedded and portable designs. The antenna is mounted using integrated pins and double-sided adhesive, enabling straightforward installation and secure placement within the device enclosure.

Typical Applications:

- Iridium® Satellite Communications
- Asset Tracking Devices
- Emergency Communication Systems
- Maritime Monitoring Equipment
- Remote Telemetry Systems
- Industrial IoT Devices
- Personal Satellite Communicators

The **IP.1621.25.4.A.02** has been selected and optimized for its intended device environment to provide dependable Iridium® performance. The antenna is certified by Iridium® for commercial use with the Iridium Communications System, offering designers a trusted solution for satellite-enabled applications requiring compact size and reliable connectivity.

For integration support, performance testing, tuning services, or additional technical assistance, please contact your regional Taoglas customer support team.

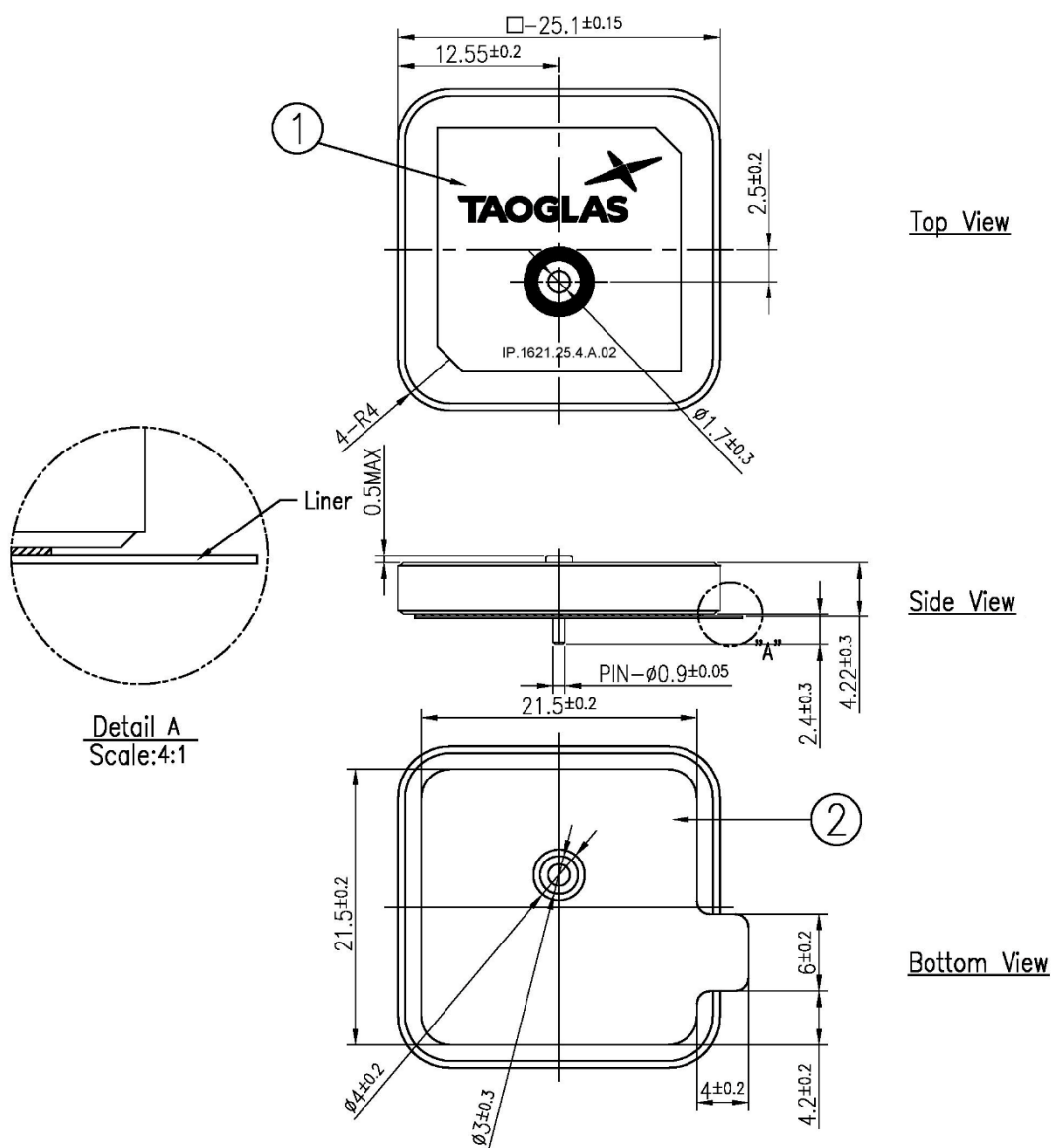
2. Specification

Electrical								
Band	Frequency (MHz)	Efficiency (%)	Average Gain (dB)	Peak Gain (dBi)	Impedance	Polarization	Radiation Pattern	Max. input power
Iridium	1616-1627	87.6	-0.57	5.02	50 Ω	RHCP	Omni directional	2W
All testing was completed on a 70x70mm Ground Plane.								

Mechanical	
Dimensions	25.0 x 25.0 x 4.0mm
Weight	5g
Material	Ceramic
Pin Dimension	ψ 0.9 x 2.4mm

Environmental	
Operation Temperature	-40°C to 85°C
Storage Temperature	-40°C to 85°C
Relative Humidity	Non-condensing 40°C 95% RH
Soldering Temperature	290°C for 3 seconds max.

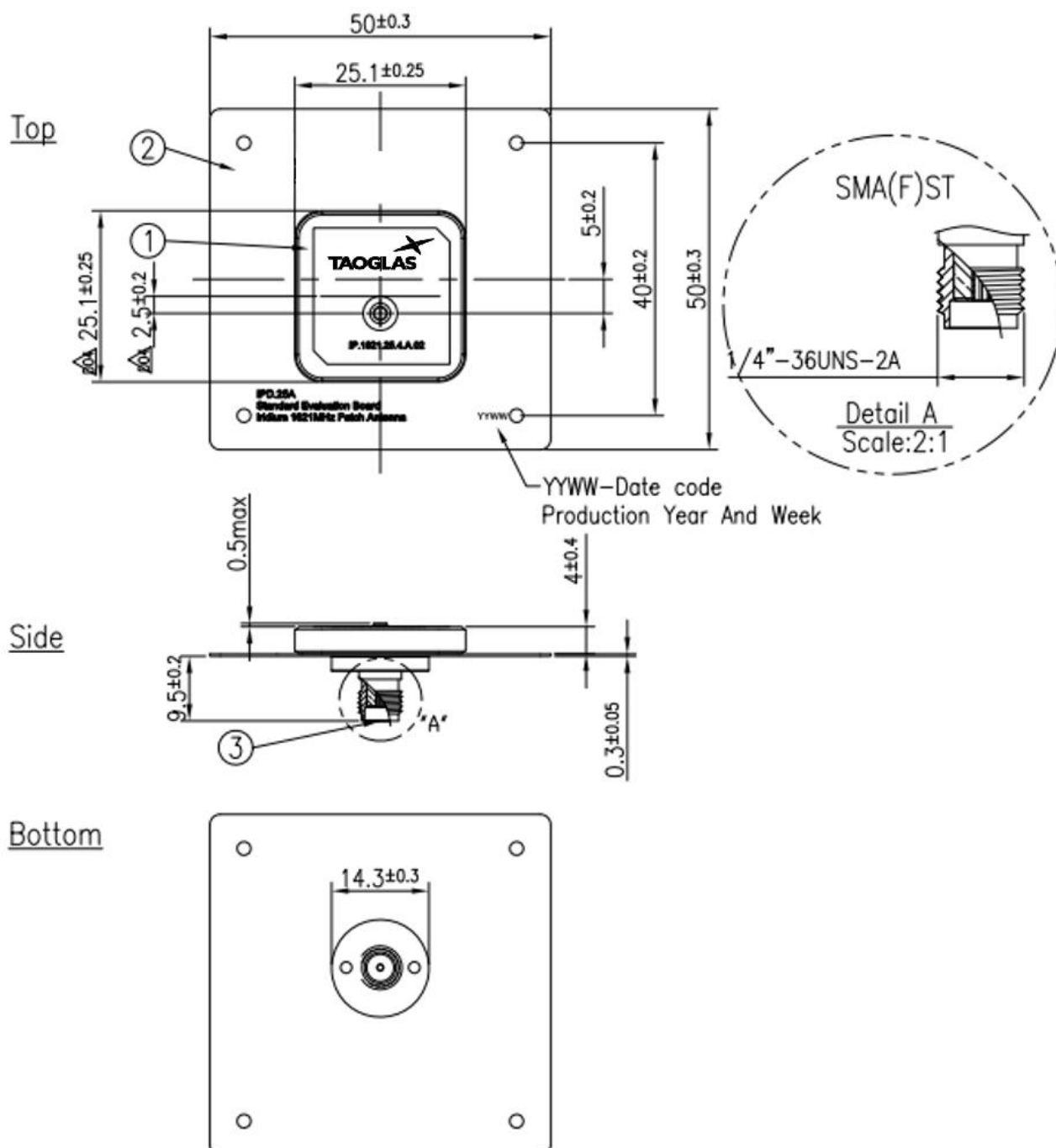
3. Mechanical Drawing



	Name	P/N	Material	Finish	QTY
1	P.25H White Patch (25.1x25.1x0.15mm)	001514C000007A	Ceramic	Clear	1
2	Double sided Adhesive	001013C180007A	NETO 5015	White Liner	1

4. Evaluation Board

The IP.1621.25.4.A.02 is designed with 50.0 x 50.0 mm square metal plane, put the antenna at the center of the metal ground, and then the antenna will have excellent performance. The recommendation setup is shown as follows.



5. Antenna Integration Guide

The following is an example on how to integrate the IP.1621.25.4.A.02 into a design. This antenna has one pin, which is used for the RF Feed. Taoglas recommends using a minimum of 50x50mm ground plane (PCB) to ensure optimal performance.



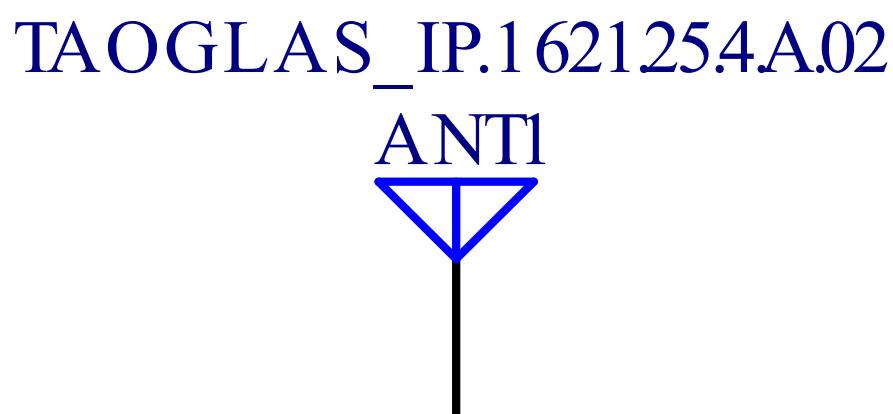
Top view of PCB reference design

Please find the Integration files in Altium, 2D formats and the 3D model for the IP.1621.25.4.A.02 here:
<https://www.taoglas.com/product/ip-1621-25-4-a-02-iridium-patch-antenna-25mm>

5.1 Schematic and Symbol Definition

The circuit symbol for the IP.1621.25.4.A.02 is shown below. The antenna has 1 pin as indicated below.

Pin	Description
1	RF Feed



Above is a schematic symbol of IP.1621.25.4.A.02 and a table of the pin definitions.

5.2 Antenna Footprint

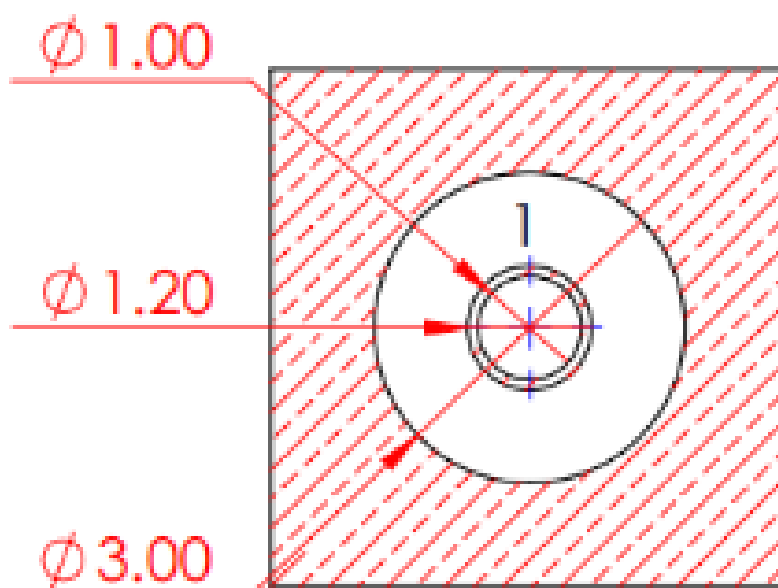


Pin	Description
1	RF Feed

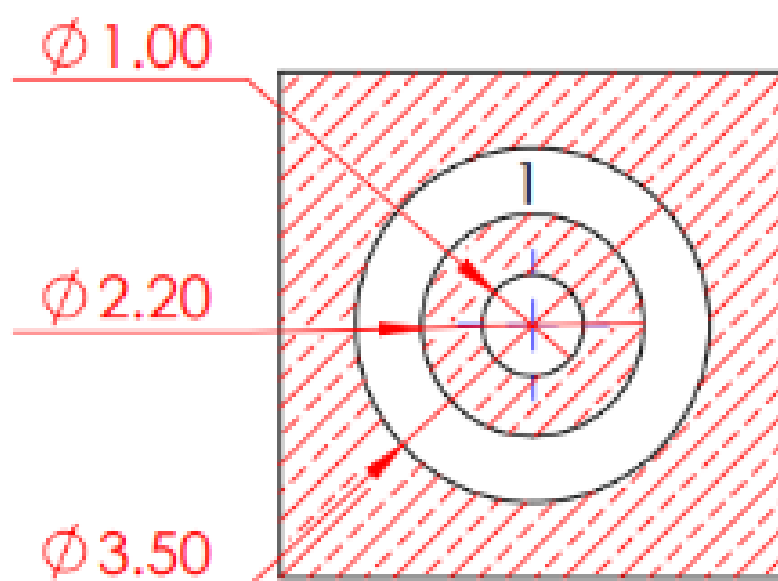
5.3 Copper Clearance

The footprint and clearance on the PCB must comply with the antenna's specification. The PCB layout shown in the diagrams below demonstrates the IP.1621.25.4.A.02 clearance area for Pin 1 (RF Feed Pad). The bottom copper keep out area only applies to the bottom layer and the top copper keep out area applies to all other layers.

There should be a $\varnothing 3\text{mm}$ copper clearance around the antenna pins on the top side of the PCB with a $\varnothing 3.5\text{mm}$ copper clearance around the antenna pins on the bottom side.



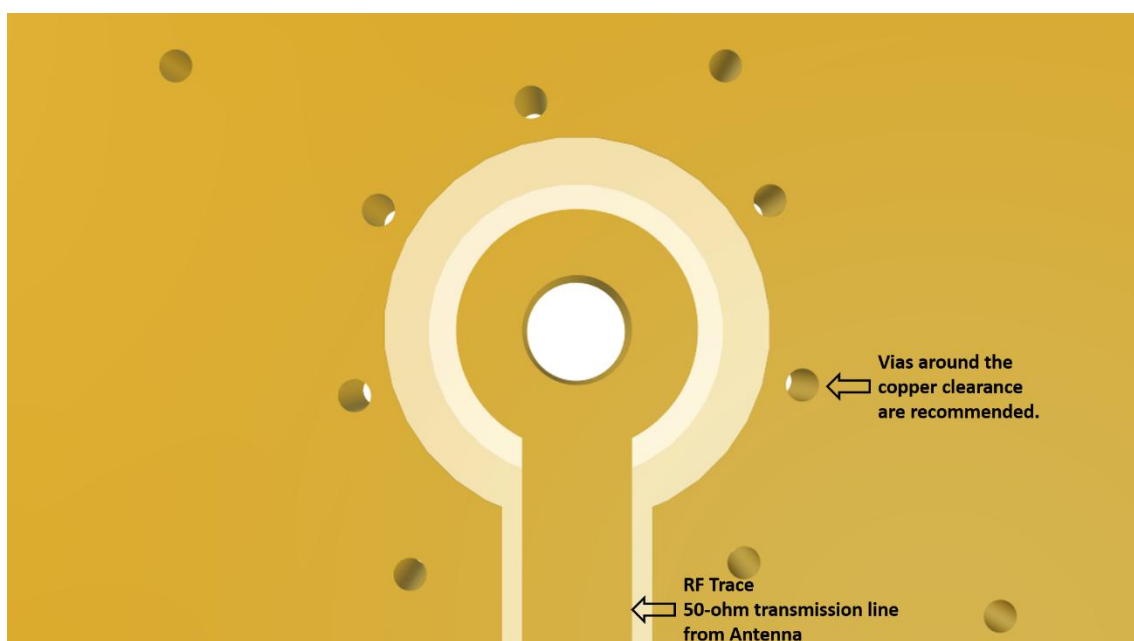
Top



Bottom

5.4 Antenna Integration

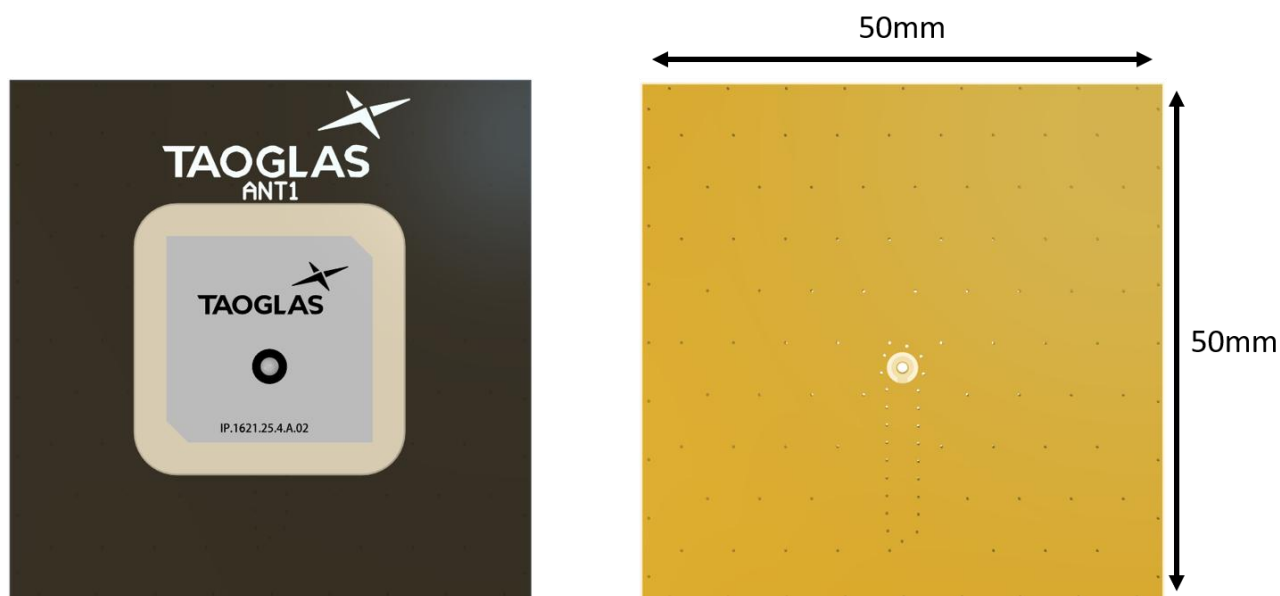
The IP.1621.25.4.A.02 should be placed in the centre of the PCB to take advantage of the ground plane. The RF traces must maintain a 50 Ohm transmission line. Ground vias should be placed around the copper clearance area and the transmission line. Note that depending on the design application, tuning may be required for optimal performance. This may be achieved using a 'pi' matching network or custom tuning of the patch antenna.



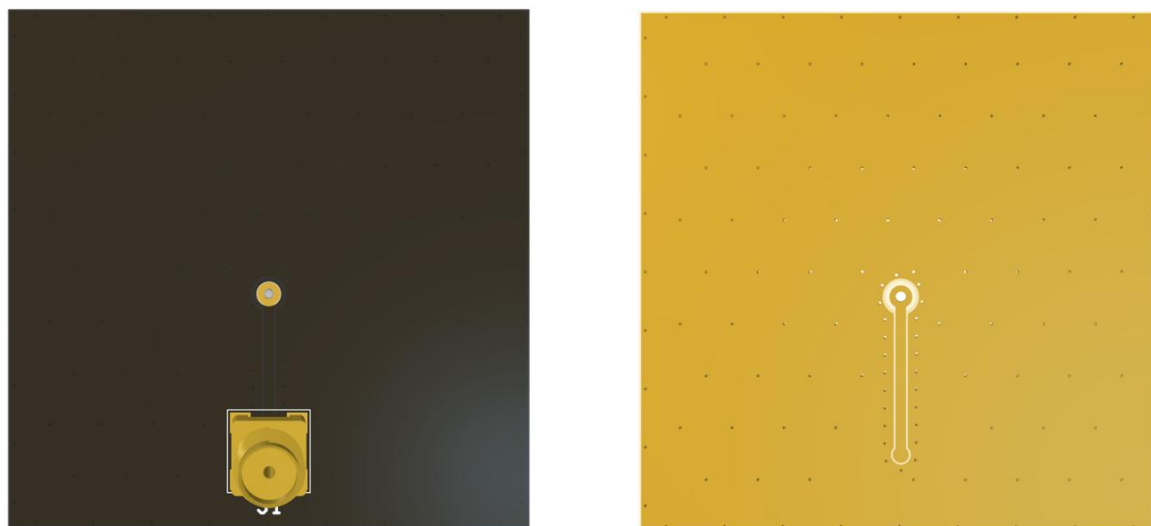
Bottom view of the PCB Reference Design, showing transmission lines and integration notes.

5.5 Final Integration

The bottom side image shown below highlights the antenna transmission line. Taoglas recommends using a minimum of 50x50mm ground plane to ensure optimal performance.



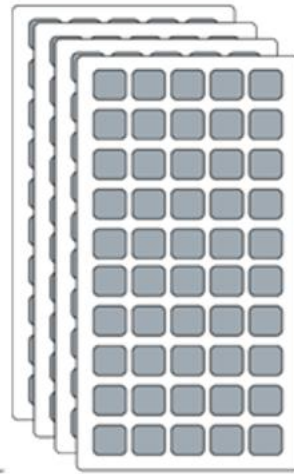
Top Side (50x50mm example PCB Reference Design)



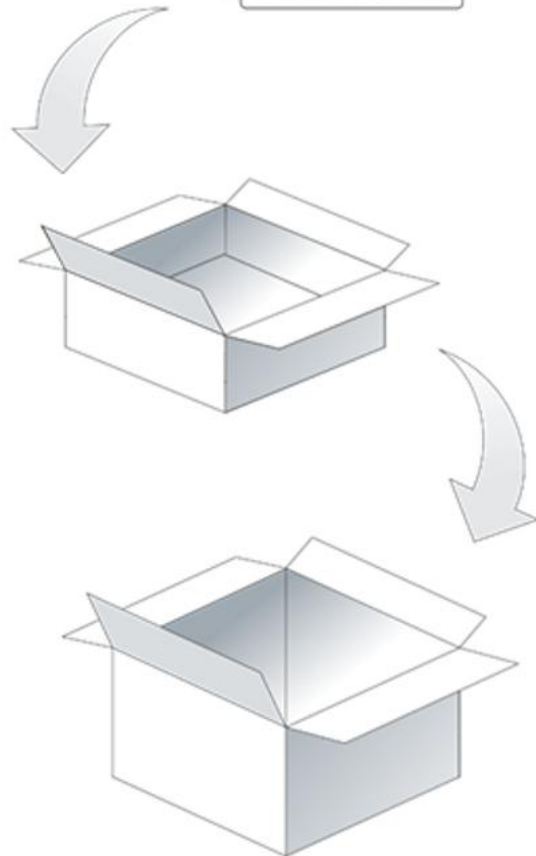
Bottom Side

6. Packaging

50 pcs per tray



200 pcs per Inner Carton



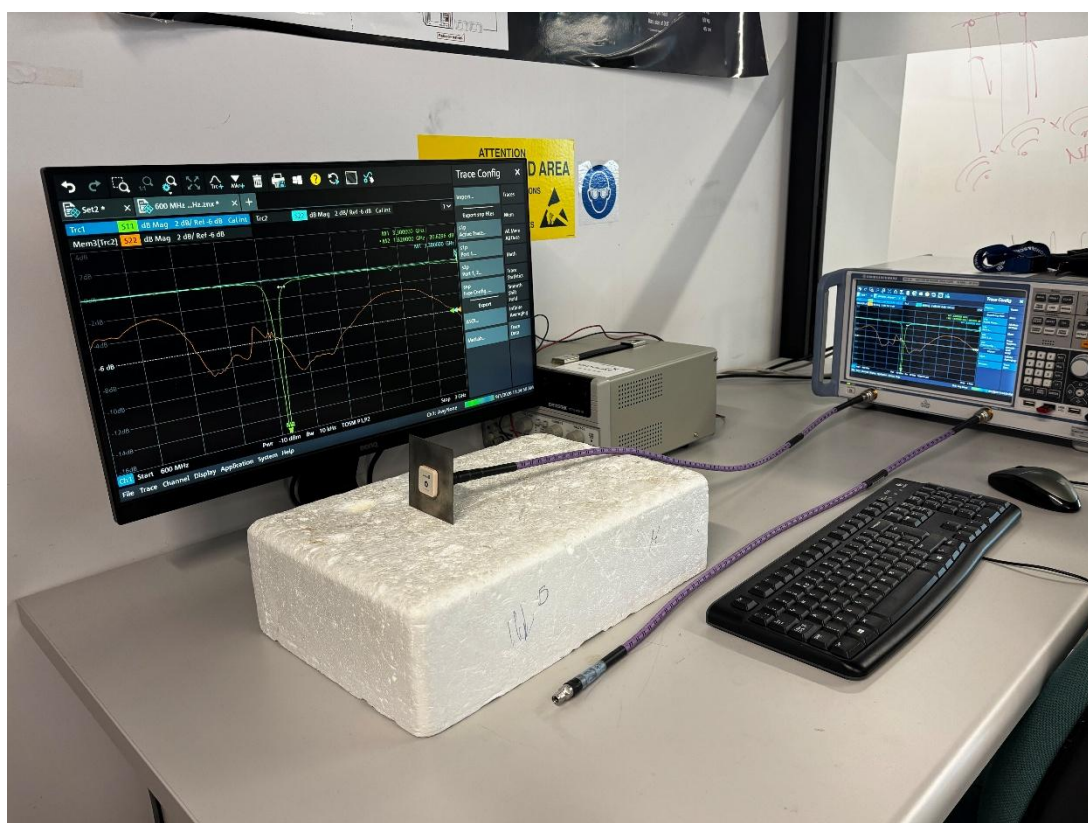
800 pcs per Carton

7. Antenna Characteristics

7.1 Test Setup

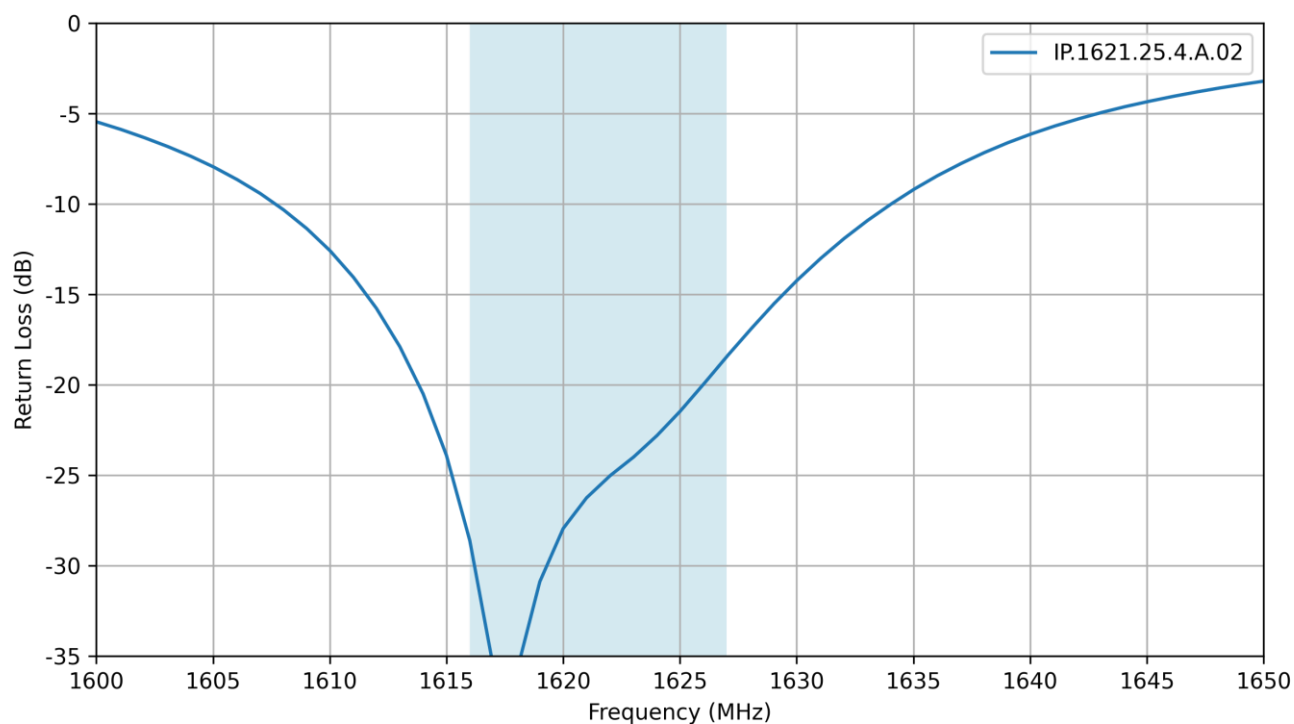


Vector Network Analyzer

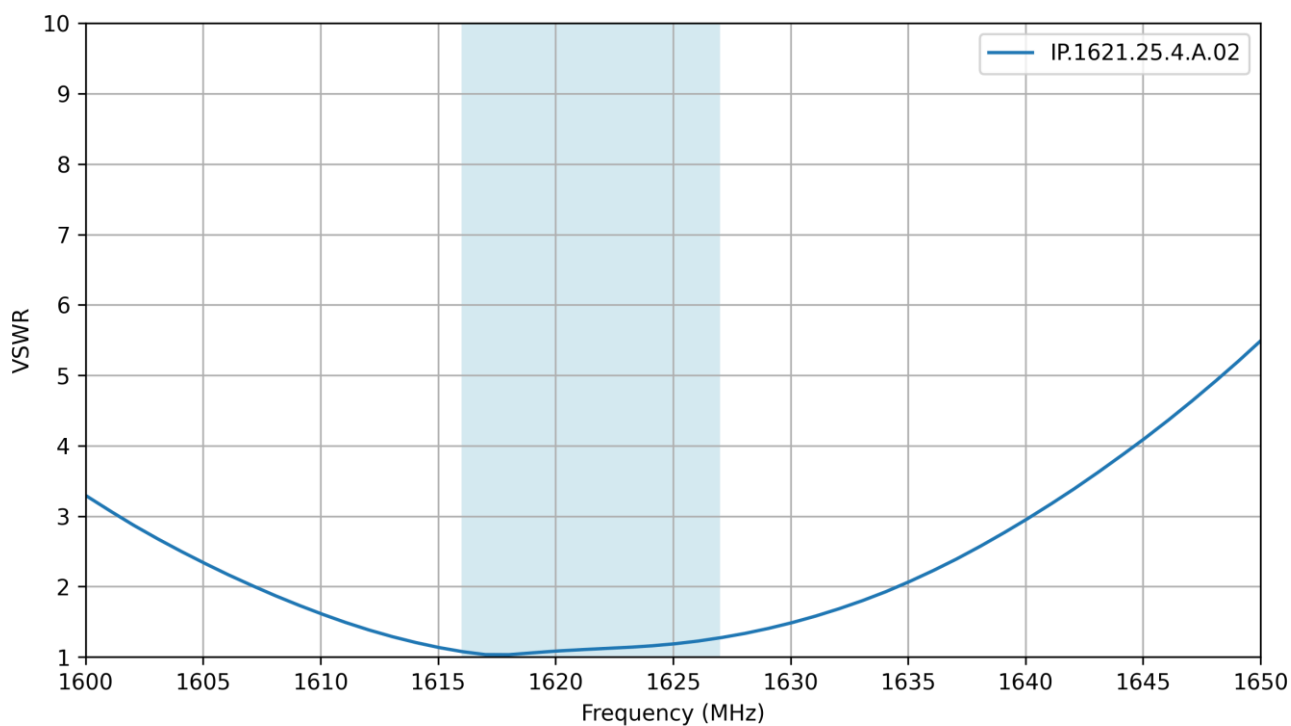


VNA Test Set-up on a 70x70mm Ground Plane

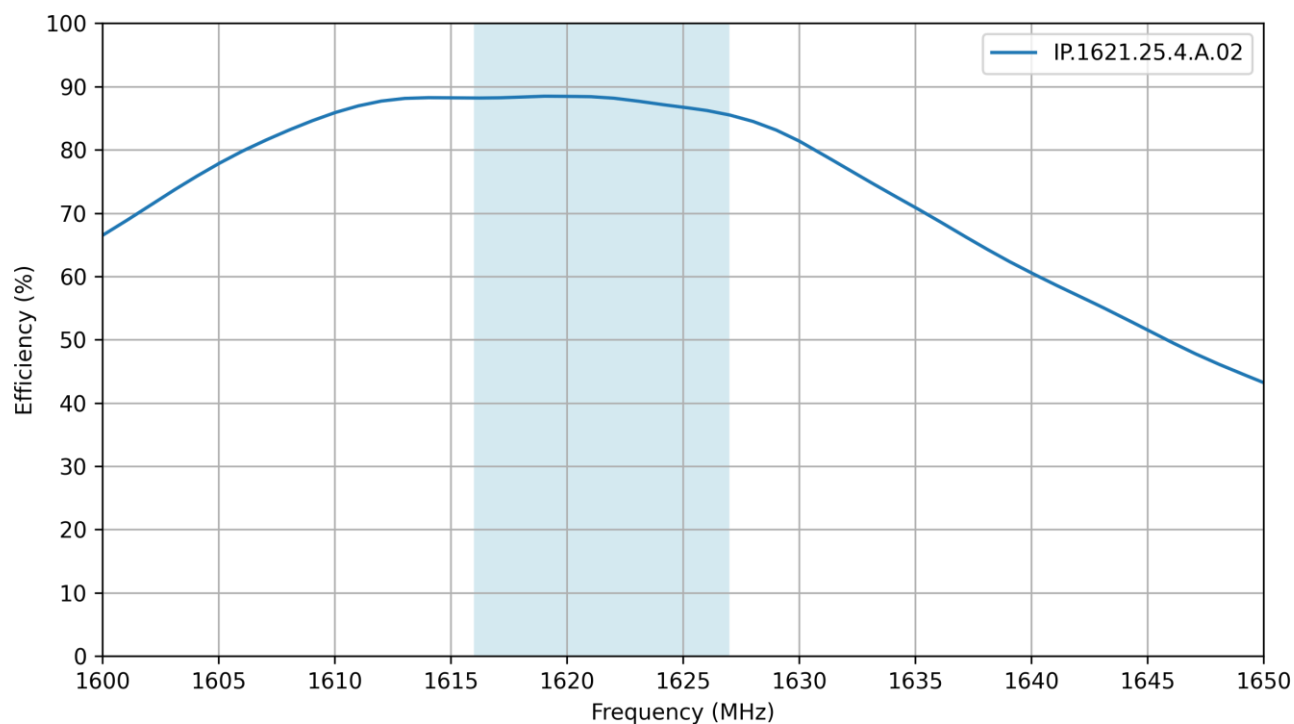
7.2 Return Loss



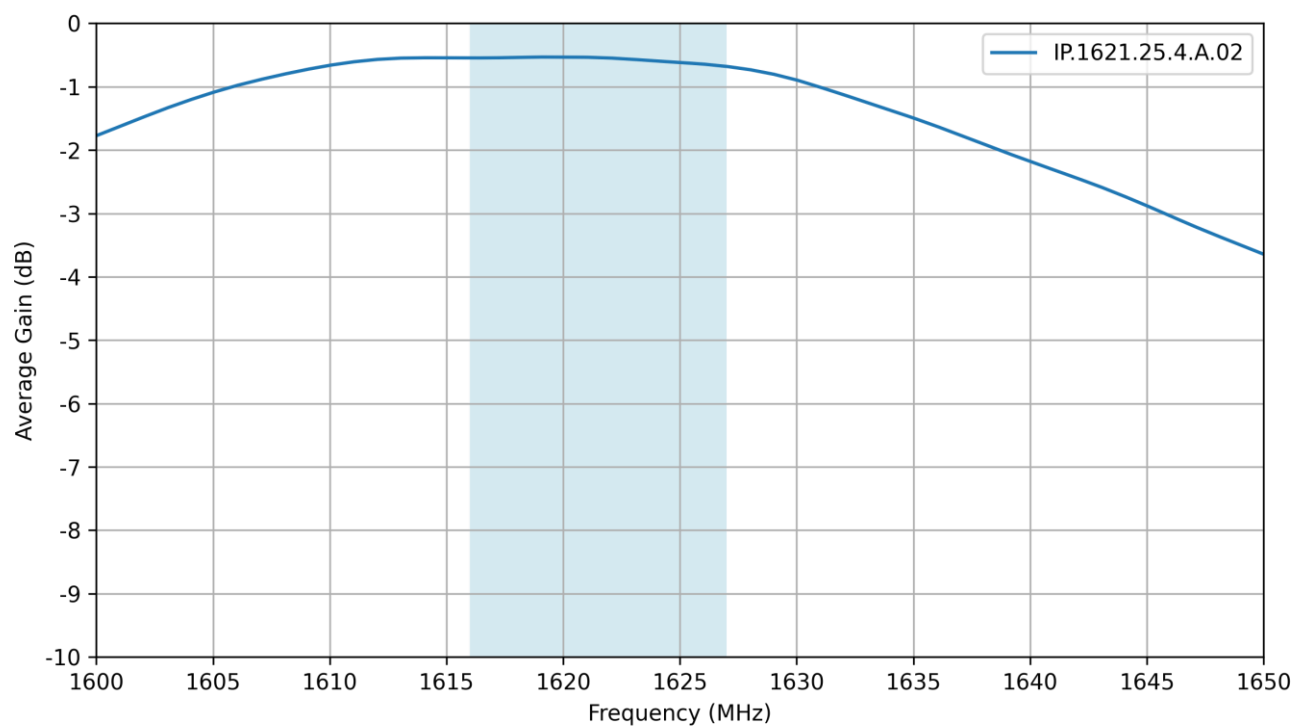
7.3 VSWR



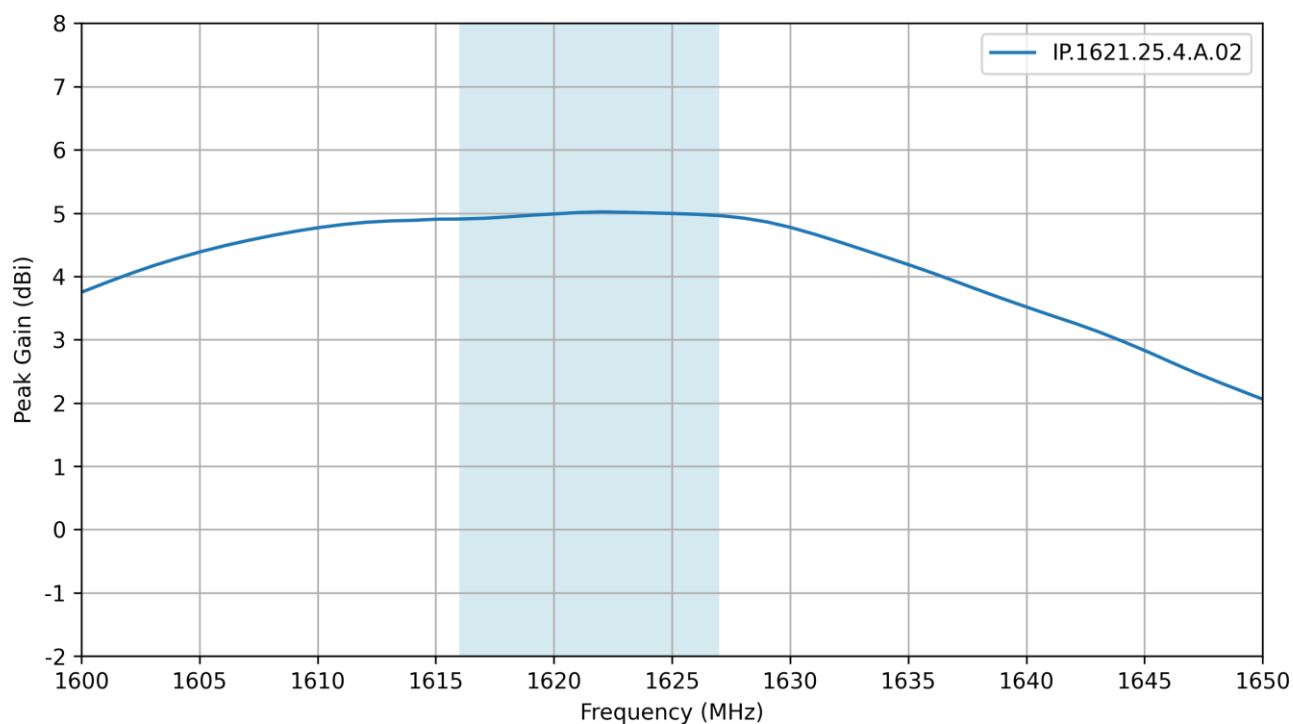
7.4 Efficiency



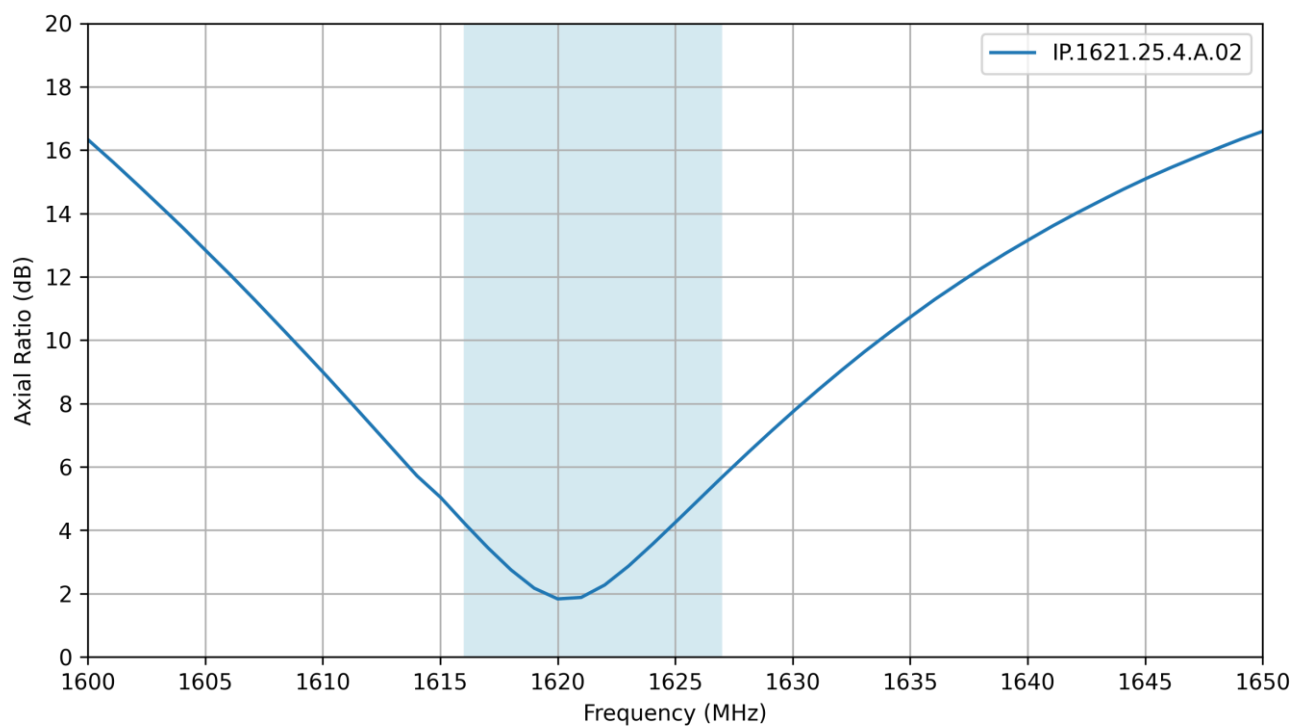
7.5 Average Gain



7.6 Peak Gain

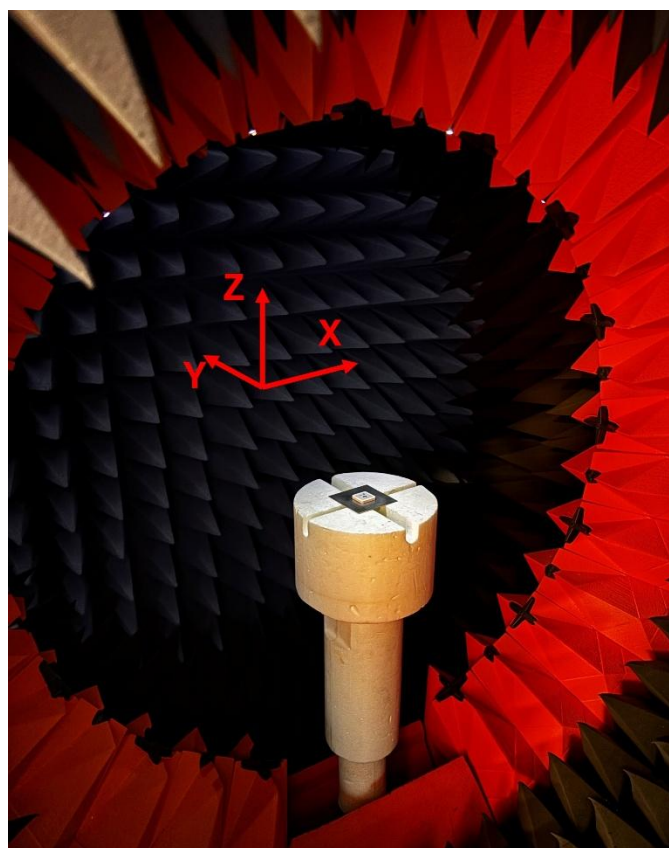
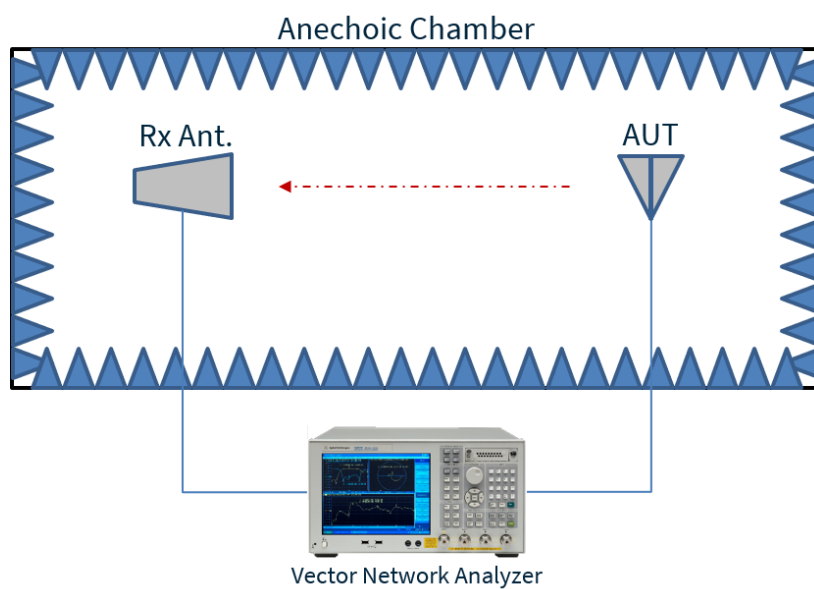


7.7 Axial Ratio



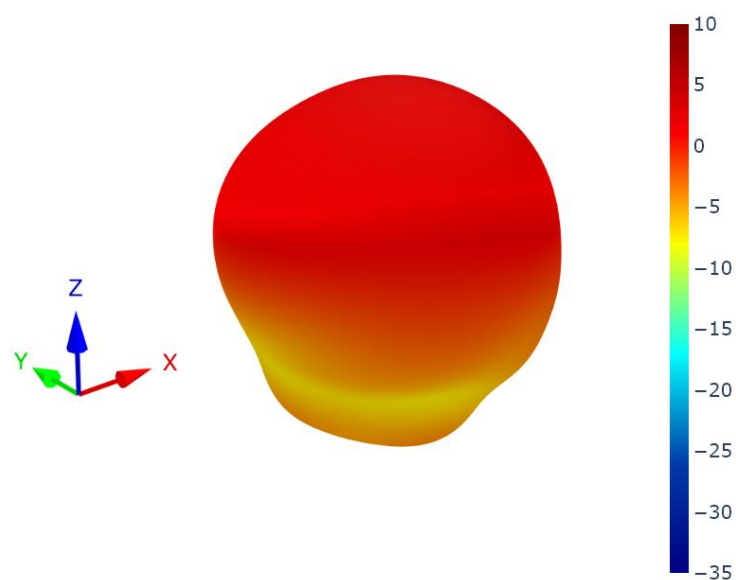
8. Radiation Patterns

8.1 Test Setup

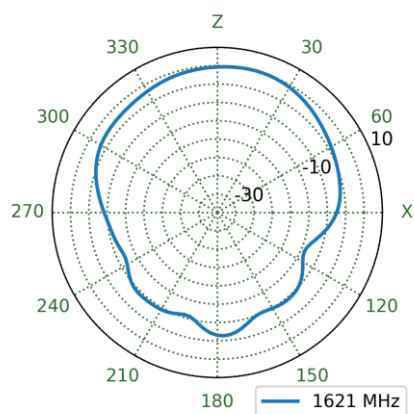


Chamber Test Set-up on a 70x70mm Ground Plane

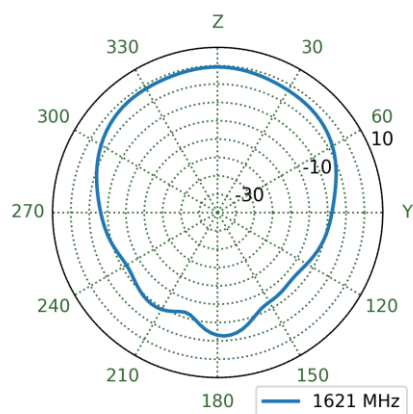
8.2 Patterns at 1621 MHz



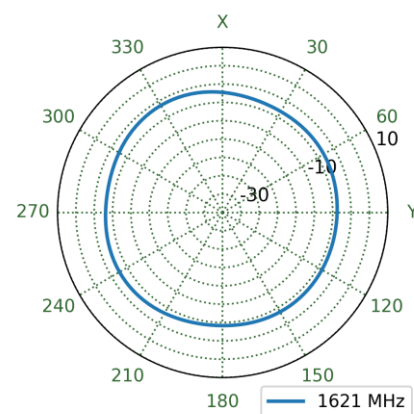
XZ Plane



YZ Plane



XY Plane



Changelog for the datasheet

SPE-11-8-017 – IP.1621.25.4.A.02

Revision: J (Current Version)

Date:	2026-09-17
Changes:	Full datasheet update.
Changes Made by:	Gary West

Previous Revisions

Revision: I

Date:	2021-06-21
Changes:	Updated Pin Length to 2.4mm Updated Drawing
Changes Made by:	Dan Cantwell

Revision: D

Date:	2013-06-19
Changes:	Ameneded Typo on Layout Drawing
Changes Made by:	Aine Doyle

Revision: H

Date:	2016-10-05
Changes:	Updated dimensions, and tollerances
Changes Made by:	Andy Mahoney

Revision: C

Date:	2012-04-12
Changes:	Update
Changes Made by:	Technical Writer

Revision: G

Date:	2016-08-18
Changes:	Updated with disclaimer and cleaned up inconsistencies.
Changes Made by:	Andy Mahoney

Revision: B

Date:	2011-07-19
Changes:	Update
Changes Made by:	Technical Writer

Revision: F

Date:	2015-02-16
Changes:	amended Pin Length and Packaging
Changes Made by:	Aine Doyle

Revision: A (Initial Release)

Date:	2011-05-24
Changes:	Initial Release
Changes Made by:	Technical Writer

Revision: E

Date:	2014-08-11
Changes:	Added EVB
Changes Made by:	Aine Doyle



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